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Trench gate field-stop IGBT, M series 1200 V, 8 A low-loss

Datasheet - production data

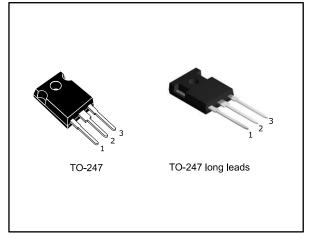
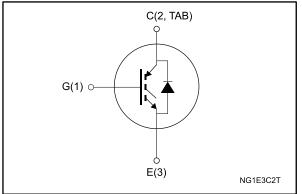


Figure 1: Internal schematic diagram



Features

- 10 μs of short-circuit withstand time
- V_{CE(sat)} = 1.85 V (typ.) @ I_C = 8 A
- Tight parameter distribution
- Safer paralleling
- Low thermal resistance
- Soft and very fast recovery antiparallel diode

Applications

- Industrial drives
- UPS
- Solar
- Welding

Description

These devices are IGBTs developed using an advanced proprietary trench gate field-stop structure. These devices are part of the M series IGBTs, which represent an optimal balance between inverter system performance and efficiency where low-loss and short-circuit functionality are essential. Furthermore, the positive $V_{CE(sat)}$ temperature coefficient and tight parameter distribution result in safer paralleling operation.

Table 1: Device summary

Order code	Marking	Package	Packing
STGW8M120DF3	C0M100DE0	TO-247	Tube
STGWA8M120DF3	G8M120DF3	TO-247 long leads	Tube

This is information on a product in full production.

Contents

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1 Electrical ratings

Table	2:	Absolute	maximum	ratings
Tuble	<u> </u>	Absolute	maximum	ratings

Symbol	Parameter	Value	Unit
VCES	Collector-emitter voltage (V _{GE} = 0 V)	1200	V
lc	Continuous collector current at T _C = 25 °C	16	А
lc	Continuous collector current at Tc = 100 °C	8	А
ICP ⁽¹⁾	Pulsed collector current	32	А
V_{GE}	Gate-emitter voltage	±20	V
lF	Continuous forward current at $T_C = 25 \text{ °C}$	16	А
lF	Continuous forward current at T _c = 100 °C	8	А
I _{FP} ⁽¹⁾	Pulsed forward current	32	А
Ртот	Total dissipation at $T_C = 25 \text{ °C}$	167	W
Tstg	Storage temperature range	-55 to 150	°C
TJ	Operating junction temperature range	-55 to 175	°C

Notes:

 $\ensuremath{^{(1)}}\ensuremath{\mathsf{Pulse}}$ width limited by maximum junction temperature.

Table 3: Thermal data

Symbol	Parameter	Value	Unit
RthJC	Thermal resistance junction-case IGBT	0.9	°C/W
RthJC	Thermal resistance junction-case diode	1.47	°C/W
RthJA	Thermal resistance junction-ambient	50	°C/W



2 Electrical characteristics

 $T_C = 25$ °C unless otherwise specified

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
$V_{(BR)CES}$	Collector-emitter breakdown voltage	$V_{GE} = 0 V, I_C = 2 mA$	1200			V
		$V_{GE} = 15 \text{ V}, I_{C} = 8 \text{ A}$		1.85	2.3	
V _{CE(sat)}	Collector-emitter saturation voltage	$V_{GE} = 15 V, I_{C} = 8 A, T_{J} = 125 \ ^{\circ}C$		2.1		v
	Voltage	$V_{GE} = 15 \text{ V}, I_C = 8 \text{ A}, T_J = 175 \ ^{\circ}\text{C}$		2.2		
		IF = 8 A		2.4	3.35	
VF	Forward on-voltage	$I_F = 8 \text{ A}, T_J = 125 \text{ °C}$		1.75		V
		I _F = 8 A, T _J = 175 °C		1.55		
$V_{\text{GE}(\text{th})}$	Gate threshold voltage	$V_{CE}=V_{GE},I_C=500\;\mu A$	5	6	7	V
I _{CES}	Collector cut-off current	$V_{GE} = 0 V, V_{CE} = 1200 V$			25	μA
I _{GES}	Gate-emitter leakage current	$V_{GE} = \pm 20 \text{ V}, V_{CE} = 0 \text{ V}$			±250	nA

Table 4: Static characteristics

Table 5: Dynamic characteristics

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Cies	Input capacitance		-	542	-	
Coes	Output capacitance	V _{CE} = 25 V, f = 1 MHz, V _{GE} = 0 V	-	74.4	-	pF
Cres	Reverse transfer capacitance		-	21	-	
Qg	Total gate charge	Vcc = 960 V, Ic = 8 A,	-	32	-	
Q _{ge}	Gate-emitter charge	V _{GE} = 0 to 15 V (see <i>Figure 30: " Gate</i>	-	4.5	-	nC
Q _{gc}	Gate-collector charge	charge test circuit")	-	18.5	-	



Electrical characteristics

	Table 6: IGBT swit	ching characteristics (inductiv	e load)			
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
td(on)	Turn-on delay time			20	-	ns
tr	Current rise time			8.4	-	ns
(di/dt) _{on}	Turn-on current slope	V _{CE} = 600 V, I _C = 8 A,		800	-	A/µs
td(off)	Turn-off-delay time	$V_{GE} = 000 \text{ V}, \text{ IC} = 0 \text{ A},$ $V_{GE} = 15 \text{ V}, \text{ R}_{G} = 33 \Omega$		126	-	ns
t _f	Current fall time	(see Figure 29: "Test circuit		136	-	ns
E _{on} ⁽¹⁾	Turn-on switching energy	for inductive load switching")		0.39	-	mJ
E _{off} ⁽²⁾	Turn-off switching energy			0.37	-	mJ
Ets	Total switching energy			0.76	-	mJ
td(on)	Turn-on delay time			19	-	ns
tr	Current rise time			9.8	-	ns
(di/dt) _{on}	Turn-on current slope	$V_{CE} = 600 \text{ V}, \text{ I}_{C} = 8 \text{ A},$		656	-	A/µs
td(off)	Turn-off-delay time	V _{GE} = 15 V, R _G = 33 Ω, T _. I = 175 °C		134	-	ns
tr	Current fall time	(see Figure 29: " Test circuit		222	-	ns
Eon ⁽¹⁾	Turn-on switching energy	for inductive load switching")		0.66	-	mJ
E _{off} ⁽²⁾	Turn-off switching energy			0.58	-	mJ
Ets	Total switching energy			1.24	-	mJ
t _{sc}	Short-circuit withstand time	$\label{eq:VGE} \begin{array}{l} V_{CC} \leq \ 600 \ V, \ V_{GE} = 15 \ V, \\ T_{Jstart} \leq 150 \ ^{\circ}C \end{array}$	10		-	μs

Notes:

⁽¹⁾Including the reverse recovery of the diode

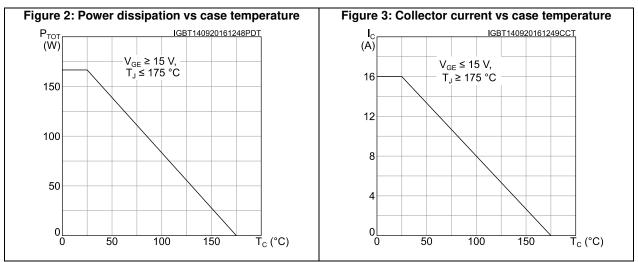
 $^{(2)}\mbox{Including the tail of the collector current}$

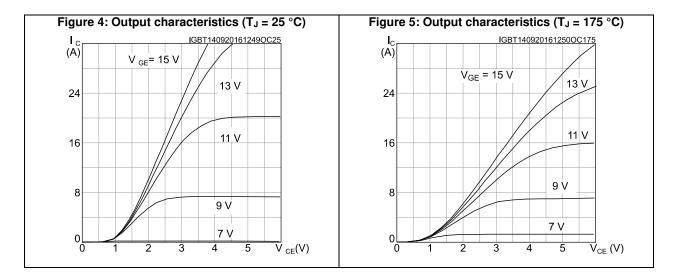
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{rr}	Reverse recovery time		-	103	-	ns
Qrr	Reverse recovery charge	$I_F = 8 A, V_R = 600 V,$	-	0.87	-	μC
I _{rrm}	Reverse recovery current	V _{GE} = 15 V, R _G = 33 Ω (di/dt = 1000 A/μs)	-	19.2	-	А
dl _{rr} /dt	Peak rate of fall of reverse recovery current during t _b	(see Figure 29: " Test circuit for inductive load switching")	-	720	-	A∕µs
Err	Reverse recovery energy		-	211	-	μJ
trr	Reverse recovery time		-	280	-	ns
Qrr	Reverse recovery charge	$I_F = 8 A, V_R = 600 V,$	-	1.9	-	μC
I _{rrm}	Reverse recovery current	V _{GE} = 15 V, T _J = 175 °C, R _G = 33 Ω (di/dt = 840 A/μs)	-	21.8	-	А
dl _{rr} /dt	Peak rate of fall of reverse recovery current during t _b	(see Figure 29: " Test circuit for inductive load switching")	-	450	-	A∕µs
Err	Reverse recovery energy		-	404	-	μJ

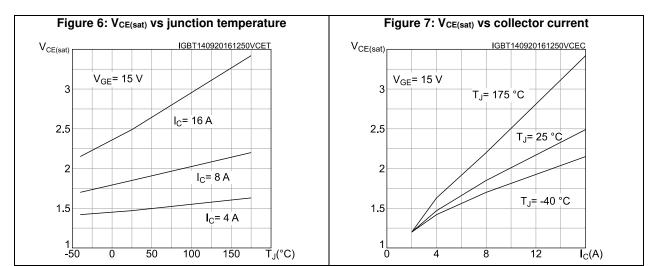
Table 7: Diode switching characteristics (inductive load)



2.1 Electrical characteristics (curves)



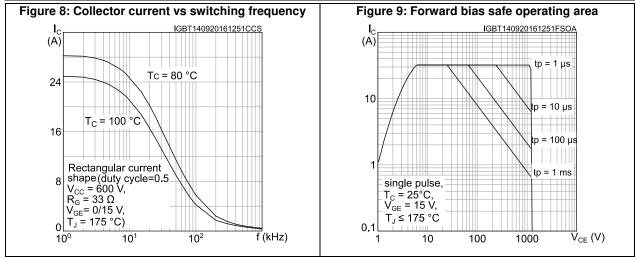


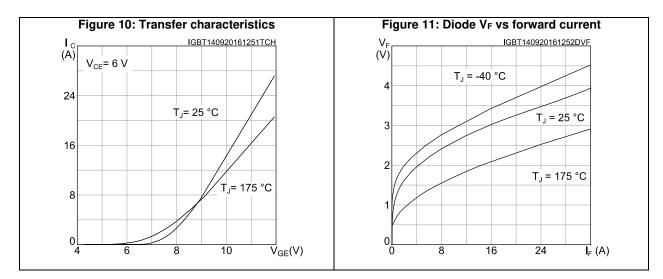


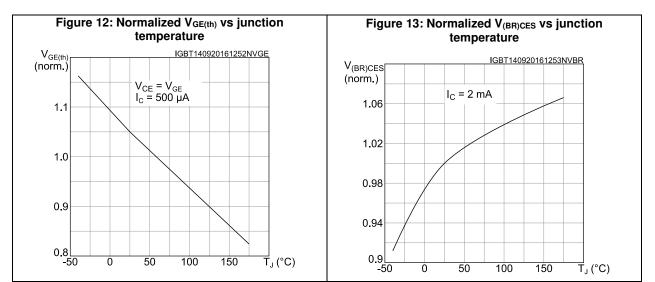


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Electrical characteristics

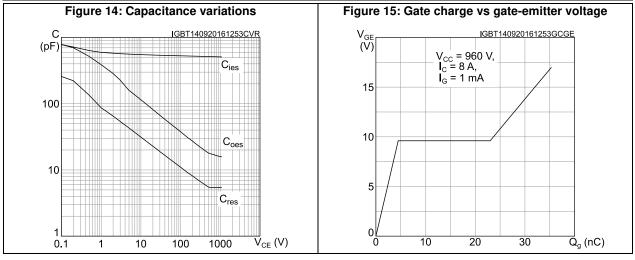


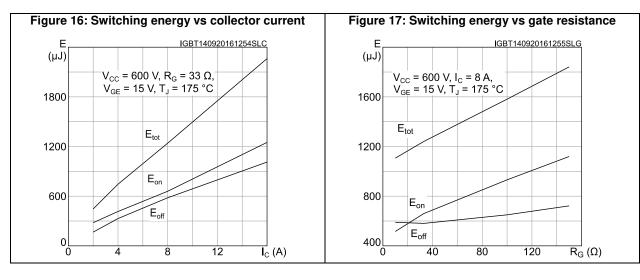


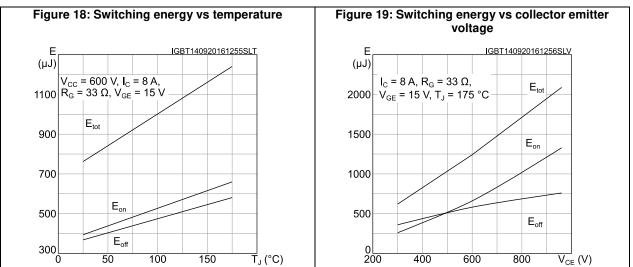


Electrical characteristics

STGW8M120DF3, STGWA8M120DF3



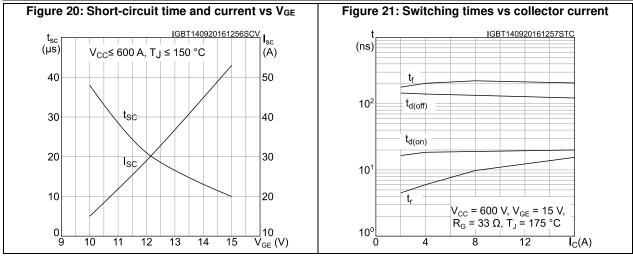


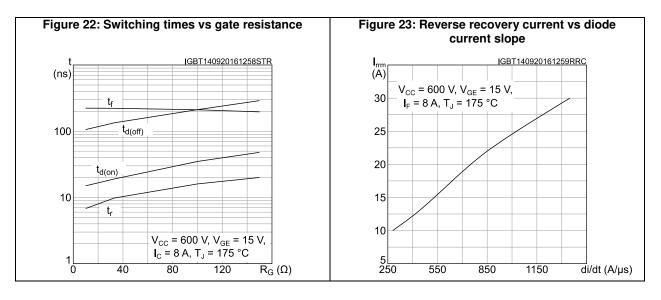


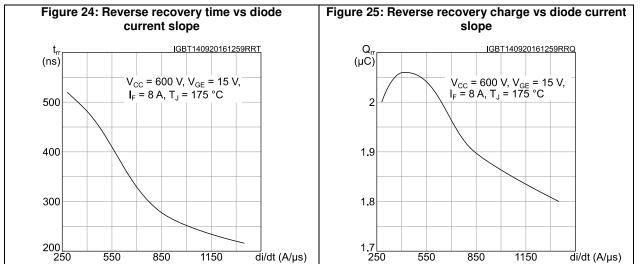


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Electrical characteristics

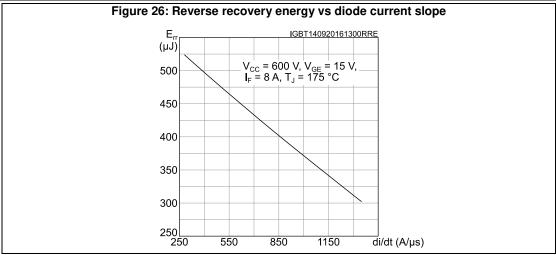


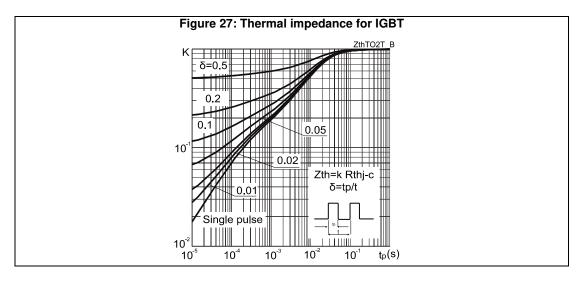


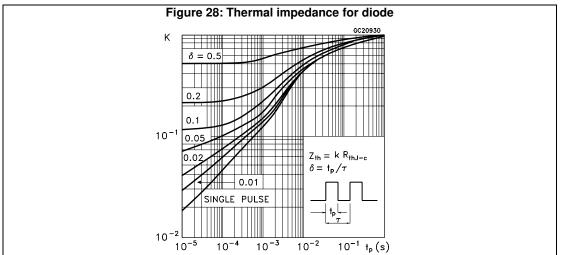


Electrical characteristics

STGW8M120DF3, STGWA8M120DF3

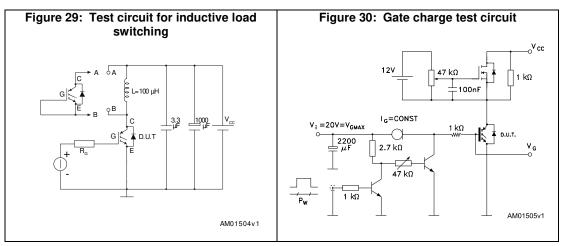


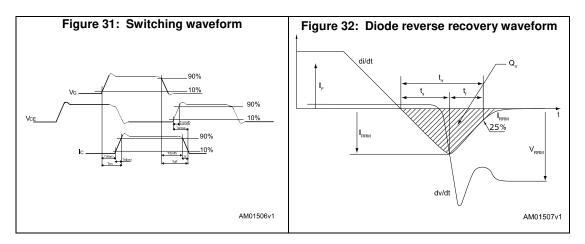






3 Test circuits



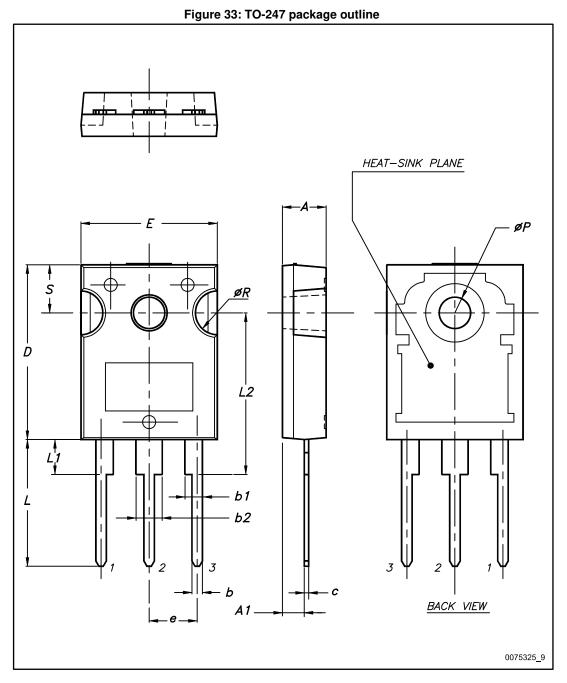




4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.

4.1 TO-247 package information





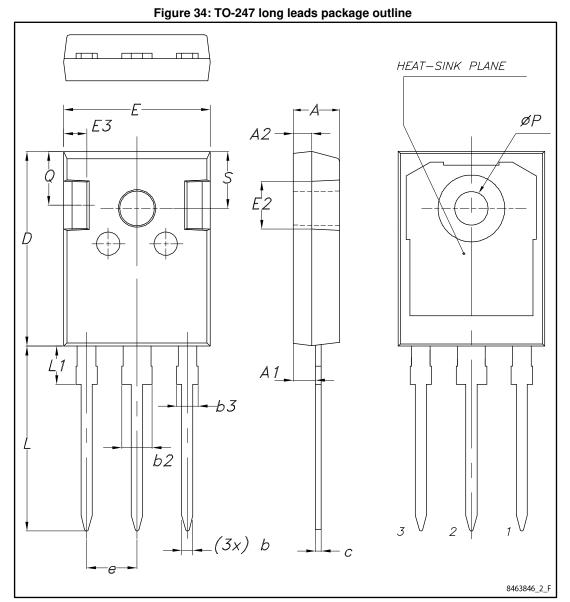
Package information

2001 5, 51 417 401112		kage mechanical data	r ackage mormation
Dim		mm	
Dim.	Min.	Тур.	Max.
A	4.85		5.15
A1	2.20		2.60
b	1.0		1.40
b1	2.0		2.40
b2	3.0		3.40
С	0.40		0.80
D	19.85		20.15
E	15.45		15.75
е	5.30	5.45	5.60
L	14.20		14.80
L1	3.70		4.30
L2		18.50	
ØP	3.55		3.65
ØR	4.50		5.50
S	5.30	5.50	5.70



4.2







Package information

	Table 9: TO-247 long lead	ls package mechanical d	ata
Dim		mm	
Dim.	Min.	Тур.	Max.
А	4.90	5.00	5.10
A1	2.31	2.41	2.51
A2	1.90	2.00	2.10
b	1.16		1.26
b2			3.25
b3			2.25
С	0.59		0.66
D	20.90	21.00	21.10
E	15.70	15.80	15.90
E2	4.90	5.00	5.10
E3	2.40	2.50	2.60
е	5.34	5.44	5.54
L	19.80	19.92	20.10
L1			4.30
Р	3.50	3.60	3.70
Q	5.60		6.00
S	6.05	6.15	6.25



Revision history 5

Table 10: Document revision histor

Date	Revision	Changes
11-May-2016	1	First release.
19-Sep-2016	2	Datasheet promoted from preliminary to production data. Updated <i>Table 2: "Absolute maximum ratings".</i> Updated <i>Section 2: "Electrical characteristics".</i> Added <i>Section 2.1: "Electrical characteristics (curves)".</i>
31-Oct-2017	3	Updated package silhouette on cover page. Updated <i>Table 4: "Static characteristics"</i> and <i>Table 5: "Dynamic characteristics"</i> . Minor text changes



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